



Customer Information Notification

201708019I

Issue Date: 28-Sep-2017

Effective Date: 28-Oct-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Change Category

☐ Wafer Fab Process

☐ Assembly Process

☐ Product Marking

☒ Test Location

☐ Design

☐ Wafer Fab Materials

☐ Assembly Materials

☐ Mechanical Specification

☐ Test Process

☐ Errata

☐ Wafer Fab Location

☐ Assembly Location

☐ Packing/Shipping/Labeling Equipment

☐ Test

☐ Electrical spec./Test coverage

S9S08LG32, S9S08SC4, S9S08RN16 and S9KEAZN8 Final Test Site Expansion from NXP-ATTJ to KESC Tianjin China

Information Notification

NXP Semiconductors announces the Final Test site expansion for the S9S08LG32, S9S08SC4, S9S08RN16 and S9KEAZN8 products associated with this notification, from the current NXP ATTJ Tianjin, China Final Test site to the KESC Tianjin, China Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Please see the attached files for additional details.

Why do we issue this Information Notification

Qualification of KESC Tianjin, China is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Cathy Yang

Position Product Engineering

e-mail address Cathy.Yang@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
S9KEAZN8AMFK	935320278557	S9KEAZN8AMFK	KINETIS E SERIES 8K FLAS	HVQFN24	RFS	BL Auto Micro Processors
S9S08SC4E0MTG	935310062574	S9S08SC4E0MTG	8BIT 4K FLASH, 256 RAM	TSSOP16	RFS	BL Auto Micro Processors